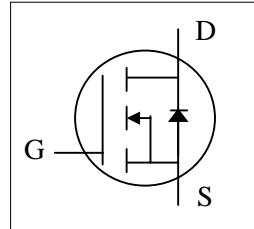
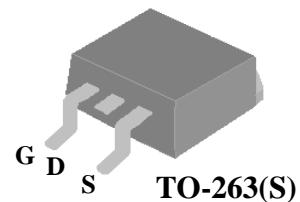




- ▼ Simple Drive Requirement
- ▼ Lower On-resistance
- ▼ Fast Switching Characteristic
- ▼ Halogen Free & RoHS Compliant Product



BV_{DSS}	80V
$R_{DS(ON)}$	13mΩ
I_D	75A



Description

AP85T08 series are from Advanced Power innovative design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The TO-263 package is widely preferred for all commercial-industrial surface mount applications using infrared reflow technique and suited for high current application due to the low connection resistance.

Absolute Maximum Ratings@ $T_J=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	80	V
V_{GS}	Gate-Source Voltage	+20	V
$I_D @ T_c = 25^\circ\text{C}$	Drain Current, $V_{GS} @ 10\text{V}$	75	A
$I_D @ T_c = 100^\circ\text{C}$	Drain Current, $V_{GS} @ 10\text{V}$	48	A
I_{DM}	Pulsed Drain Current ¹	260	A
$P_D @ T_c = 25^\circ\text{C}$	Total Power Dissipation	138	W
	Linear Derating Factor	1.11	W/°C
E_{AS}	Single Pulse Avalanche Energy ³	450	mJ
I_{AR}	Avalanche Current	30	A
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Units
R_{thj-c}	Maximum Thermal Resistance, Junction-case	0.9	°C/W
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient (PCB mount) ⁴	40	°C/W



AP85T08GS-HF

Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	80	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V, I_D=45A$	-	-	13	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	-	3	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=45A$	-	70	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=80V, V_{GS}=0V$	-	-	10	μA
	Drain-Source Leakage Current ($T_j=125^\circ C$)	$V_{DS}=64V, V_{GS}=0V$	-	-	100	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Q_g	Total Gate Charge	$I_D=45A$	-	63	100	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=64V$	-	23	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	38	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=40V$	-	30	-	ns
t_r	Rise Time	$I_D=45A$	-	100	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=10\Omega$	-	144	-	ns
t_f	Fall Time	$V_{GS}=10V$	-	173	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	6300	10080	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	670	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	350	-	pF
R_g	Gate Resistance	f=1.0MHz	-	1.1	1.7	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_S=45A, V_{GS}=0V$	-	-	1.3	V
t_{rr}	Reverse Recovery Time	$I_S=20A, V_{GS}=0V$	-	47	-	ns
Q_{rr}	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	86	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Starting $T_j=25^\circ C$, $V_{DD}=30V$, $L=1mH$, $R_G=25\Omega$, $I_{AS}=30A$.
- 4.Surface mounted on 1 in² copper pad of FR4 board

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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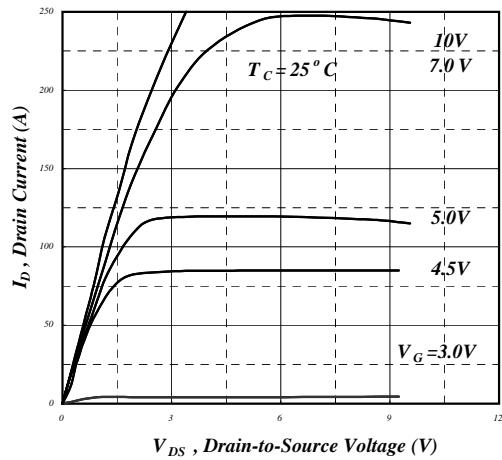


Fig 1. Typical Output Characteristics

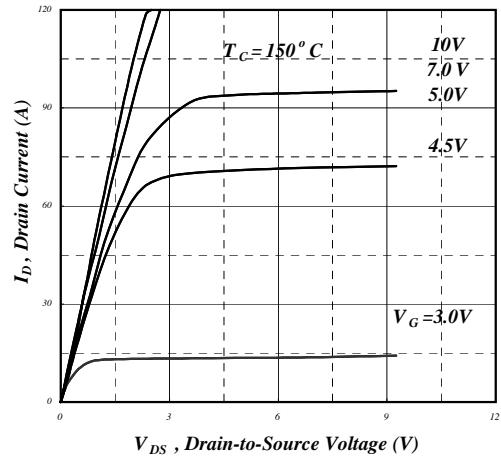


Fig 2. Typical Output Characteristics

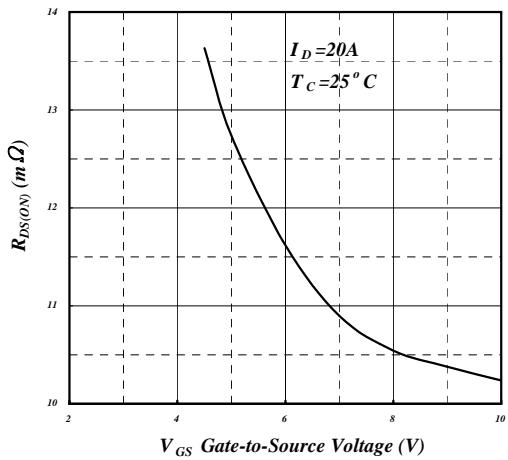


Fig 3. On-Resistance v.s. Gate Voltage

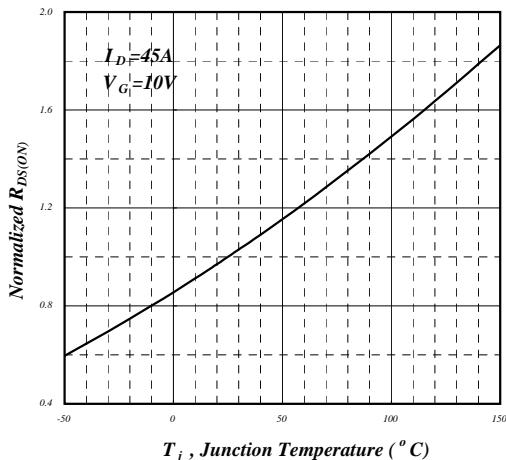


Fig 4. Normalized On-Resistance v.s. Junction Temperature

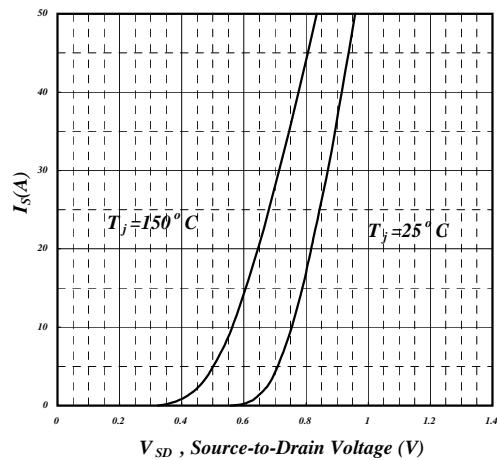


Fig 5. Forward Characteristic of Reverse Diode

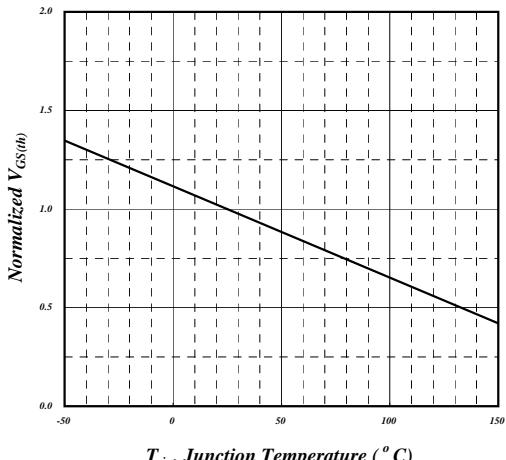
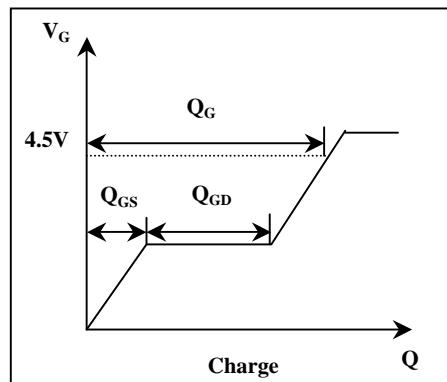
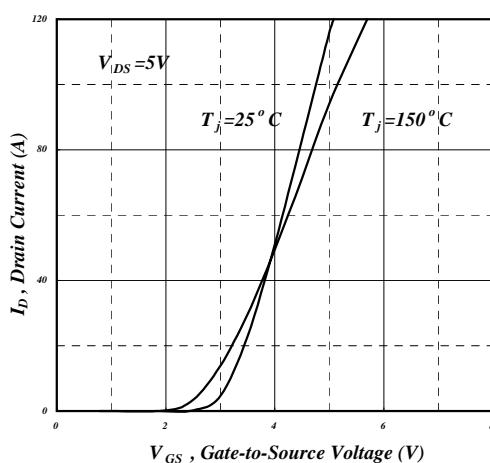
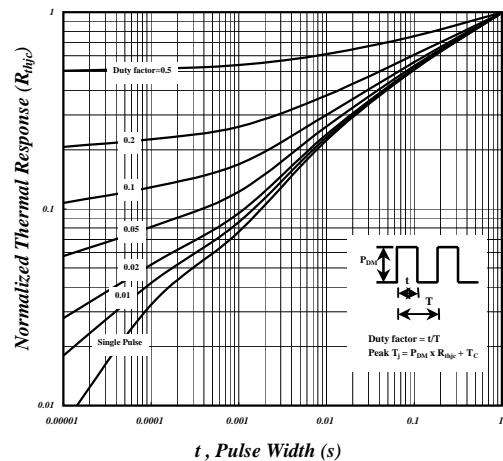
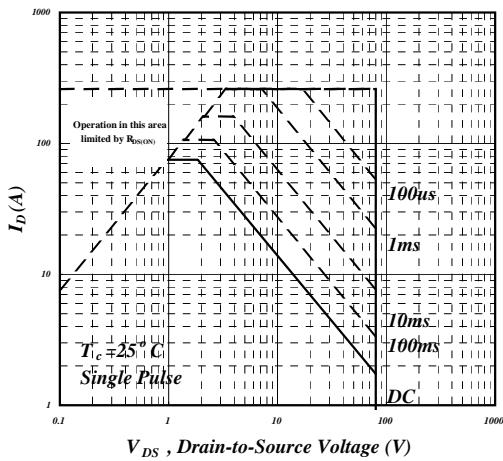
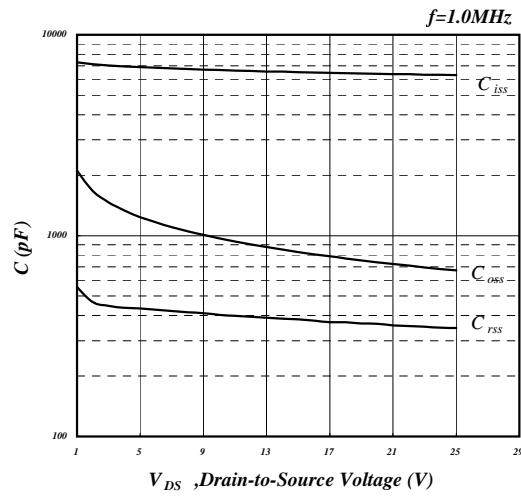
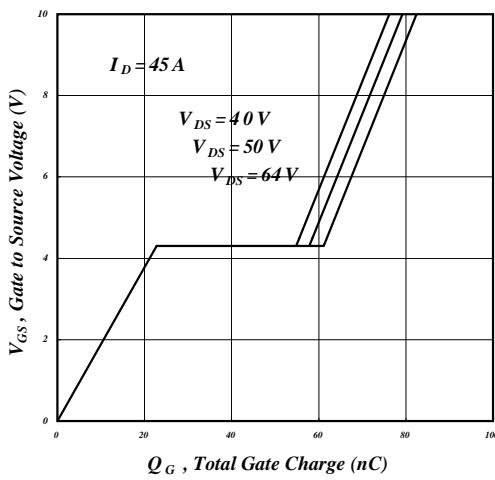


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

AP85T08GS-HF





AP85T08GS-HF

MARKING INFORMATION

